

Bipolar Transistors Silicon PNP Epitaxial Type

# HN1A01FE

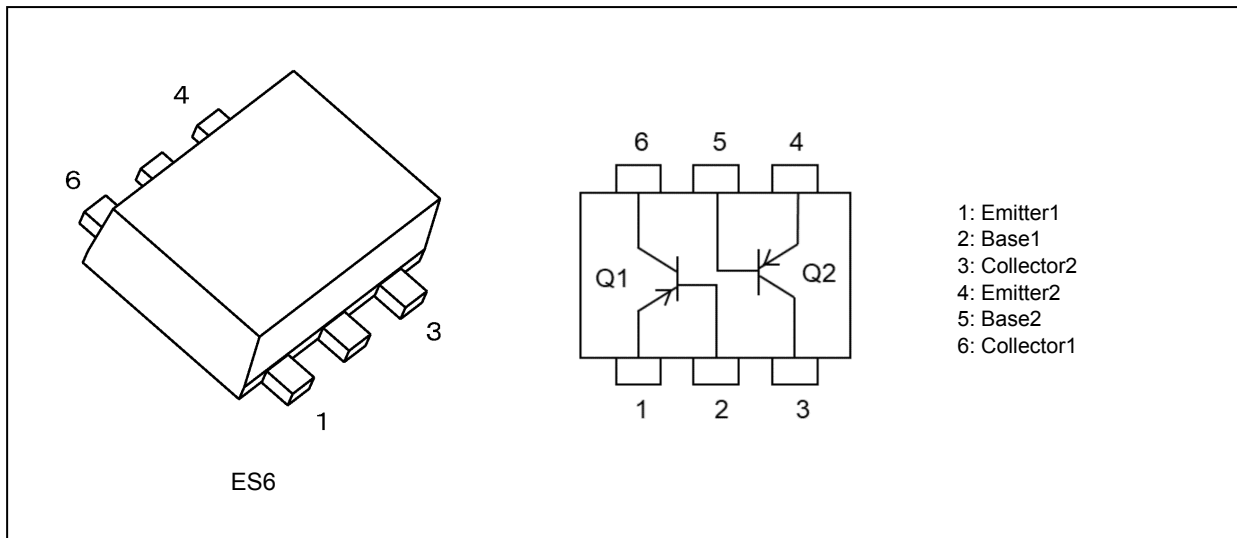
## 1. Applications

- Low-Frequency Amplifiers

## 2. Features

- (1) AEC-Q101 qualified (Please see the orderable part number list)
- (2) Small package (Dual type)
- (3) High voltage:  $V_{CEO} = -50\text{ V}$
- (4) High collector current:  $I_C = -150\text{ mA (max)}$
- (5) High  $h_{FE}$ :  $h_{FE} = 120\text{ to }400$
- (6) Excellent  $h_{FE}$  linearity:  $h_{FE}(I_C = -0.1\text{ mA})/h_{FE}(I_C = -2\text{ mA}) = 0.95\text{ (typ.)}$

## 3. Packaging and Internal Circuit



Start of commercial production  
2000-05

### 4. Orderable part number

Orderable part number		AEC-Q101	Note
HN1A01FE-Y	HN1A01FE-Y,LF	—	General Use
	HN1A01FE-Y,LXGF	YES (Note 1)	Unintended Use (Note 1)
	HN1A01FE-Y,LXHF	YES	Automotive Use
HN1A01FE-GR	HN1A01FE-GR,LF	—	General Use
	HN1A01FE-GR,LXGF	YES (Note 1)	Unintended Use (Note 1)
	HN1A01FE-GR,LXHF	YES	Automotive Use

Note 1: For more information, please contact our sales or use the inquiry form on our website.

### 5. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^\circ\text{C}$ ) (Q1, Q2 Common)

Characteristics	Note	Symbol	Rating	Unit
Collector-base voltage		$V_{CB0}$	-50	V
Collector-emitter voltage		$V_{CEO}$	-50	
Emitter-base voltage		$V_{EBO}$	-5	
Collector current		$I_C$	-150	mA
Base current		$I_B$	-30	
Collector power dissipation	(Note 1)	$P_C$	100	mW
Junction temperature		$T_j$	150	$^\circ\text{C}$
Storage temperature		$T_{stg}$	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

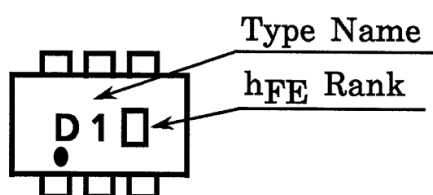
Note 1: Total rating

### 6. Electrical Characteristics (Note) (Unless otherwise specified, $T_a = 25^\circ\text{C}$ )(Q1, Q2 Common)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = -50\text{ V}, I_E = 0\text{ mA}$	—	—	-0.1	$\mu\text{A}$
Emitter cut-off current	$I_{EBO}$	$V_{EB} = -5\text{ V}, I_C = 0\text{ mA}$	—	—	-0.1	
DC current gain	$h_{FE}$	$V_{CE} = -6\text{ V}, I_C = -2\text{ mA}$	120	—	400	—
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -100\text{ mA}, I_B = -10\text{ mA}$	—	-0.1	-0.3	V
Transition frequency	$f_T$	$V_{CE} = -10\text{ V}, I_C = -1\text{ mA}$	80	—	—	MHz
Collector output capacitance	$C_{ob}$	$V_{CB} = -10\text{ V}, I_E = 0\text{ mA}, f = 1\text{ MHz}$	—	4	—	pF

Note:  $h_{FE}$  classification Y (Y): 120 to 240, GR (G): 200 to 400  
( ) marking symbol

### 7. Marking



Marking

### 8. Characteristics Curves (Note) (Q1, Q2 Common)

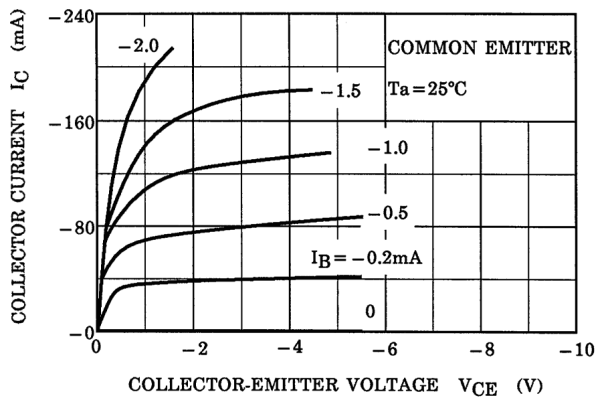


Fig. 8.1  $I_C - V_{CE}$

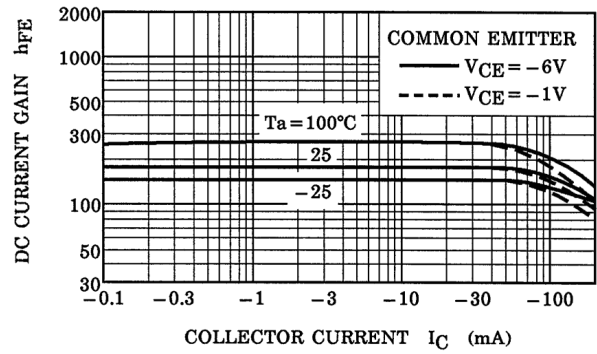


Fig. 8.2  $h_{FE} - I_C$

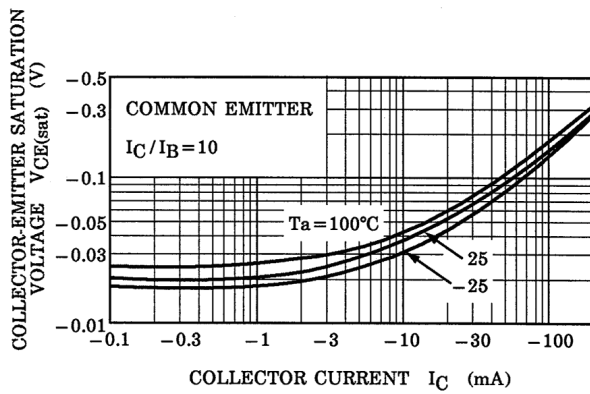


Fig. 8.3  $V_{CE(sat)} - I_C$

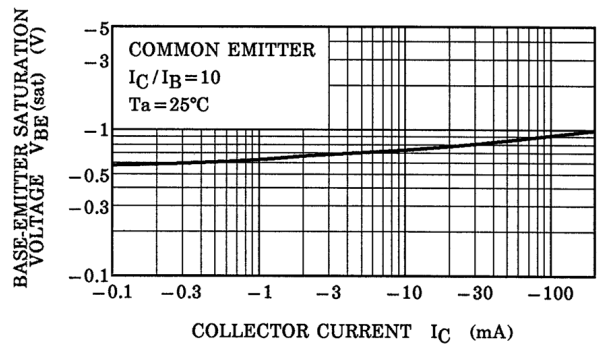


Fig. 8.4  $V_{BE(sat)} - I_C$

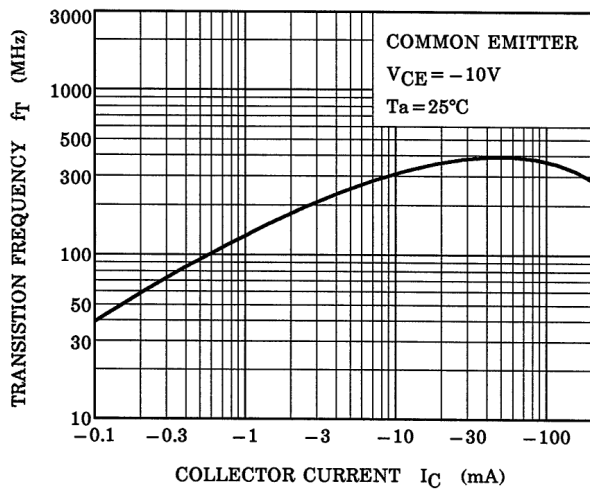


Fig. 8.5  $f_T - I_C$

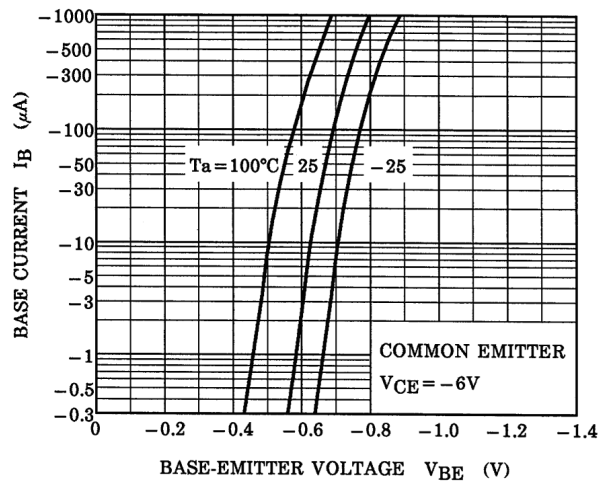


Fig. 8.6  $I_B - V_{BE}$

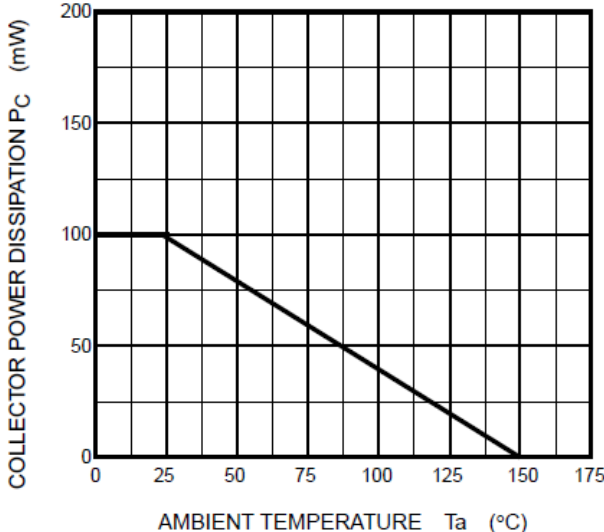


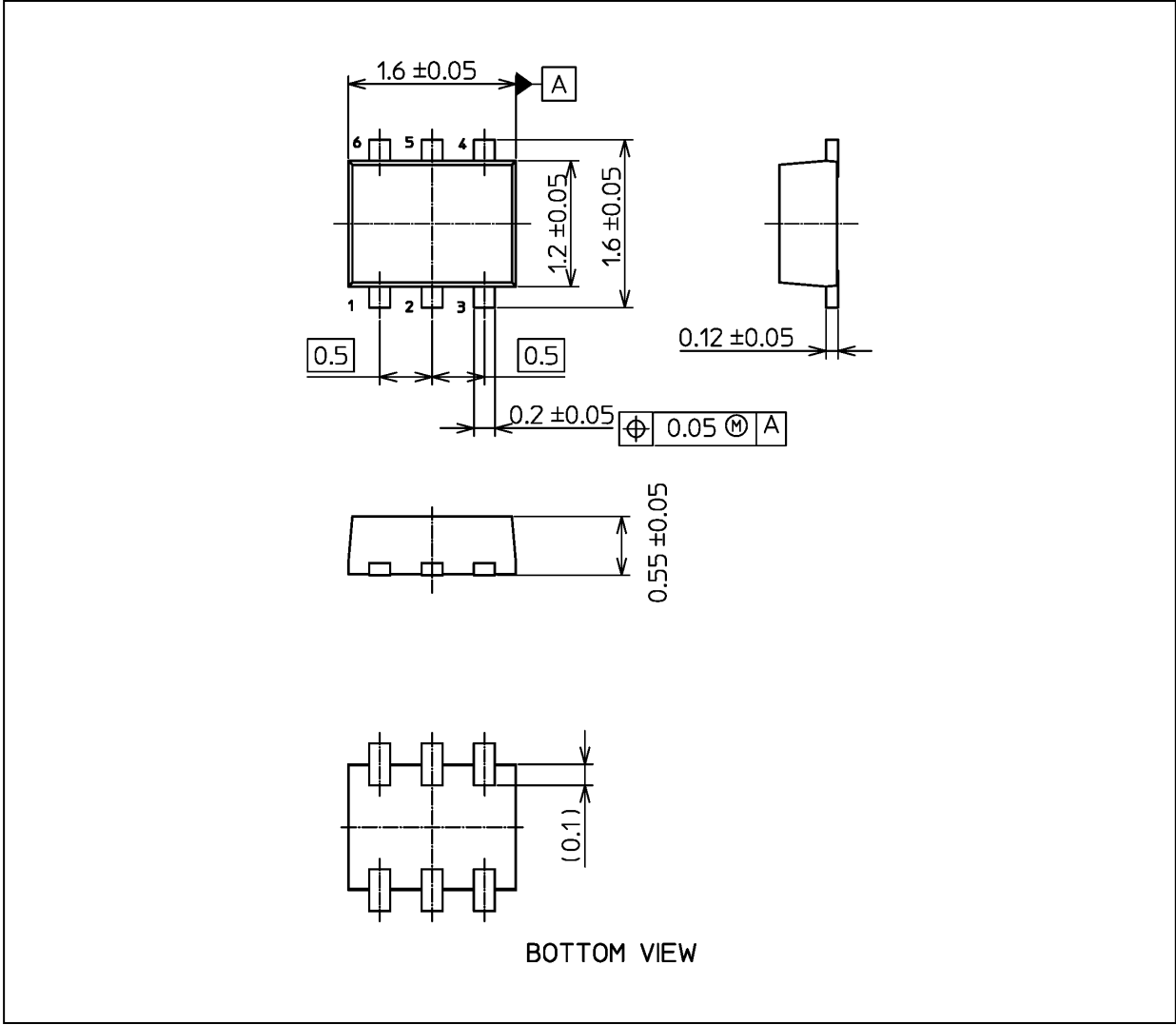
Fig. 8.7  $P_C$  (Note 1) -  $T_a$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Note 1: Total rating

Package Dimensions

Unit: mm



Weight: 3.0 mg (typ.)

Package Name(s)
Nickname: ES6

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